# 1.1GHz Dual Modulus Prescaler

The MC12026 is a high frequency, low voltage dual modulus prescaler used in phase–locked loop (PLL) applications.

The MC12026A can be used with CMOS synthesizers requiring positive edges to trigger internal counters such as Motorola's MC145xxx series in a PLL to provide tuning signals up to 1.1GHz in programmable frequency steps.

The MC12026B can be used with CMOS synthesizers requiring negative edges to trigger internal counters.

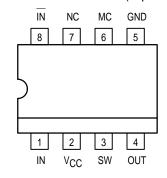
A Divide Ratio Control (SW) permits selection of an 8/9 or 16/17 divide ratio as desired.

The Modulus Control (MC) selects the proper divide number after SW has been biased to select the desired divide ratio.

### NOTE: The "B" Version Is Not Recommended for New Designs

- 1.1GHz Toggle Frequency
- Supply Voltage 4.5V to 5.5V
- Low Power 4.0mA Typical
- Operating Temperature Range of -40°C to +85°C
- The MC12026 is Pin Compatible With the MC12022
- Short Setup Time (t<sub>Set</sub>) 6ns Typical @ 1.1GHz
- Modulus Control Input Level is Compatible With Standard CMOS and TTL

#### Pinout: 8-Lead Plastic (Top View)



# MC12026A MC12026B

# **MECL PLL COMPONENTS**

÷8/9, ÷16/17
DUAL MODULUS PRESCALER



P SUFFIX 8-LEAD PLASTIC PACKAGE CASE 626-05



**D SUFFIX** 8-LEAD PLASTIC SOIC PACKAGE CASE 751-05

## **FUNCTION TABLE**

SW	MC	Divide Ratio
Н	Н	8
Н	L	9
L	Н	16
L	L	17

Note: SW:  $H = V_{CC}$ , L = OPENMC: H = 2.0V to  $V_{CC}$ ; L = GND to 0.8V

# **MAXIMUM RATINGS**

Symbol	Characteristic	Range	Unit
VCC	Power Supply Voltage, Pin 2	-0.5 to +7.0	Vdc
TA	Operating Temperature Range	-40 to +85	°C
T <sub>stg</sub>	Storage Temperature Range	-65 to +150	°C
MC	Modulus Control Input, Pin 6	-0.5 to +6.5	Vdc
IO	Maximum Output Current, Pin 4	10.0	mA

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<b>ELECTRICAL CHARACTERISTICS</b>	$(V_{CC} = 4.5 \text{ to } 5.5; T_A = -40 \text{ to } +85^{\circ}C)$

Symbol	Characteristic	Min	Тур	Max	Unit
ft	Toggle Frequency (Sin Wave)	0.1	1.4	1.1	GHz
Icc	Supply Current Output Unloaded (Pin 2)	_	4.0	5.3	mA
V <sub>IH1</sub>	Modulus Control Input High (MC)	2.0	_	Vcc	V
V <sub>IL1</sub>	Modulus Control Input Low (MC)	GND	_	0.8	V
V <sub>IH2</sub>	Divide Ratio Control Input High (SW)	V <sub>CC</sub> – 0.5V	VCC	V <sub>CC</sub> + 0.5V	V
V <sub>IL2</sub>	Divide Ratio Control Input Low (SW)	OPEN	OPEN	OPEN	_
V <sub>out</sub>	Output Voltage Swing $(R_L = 560\Omega; I_O = 5.5\text{mA})^{1}$ $(R_L = 1.1\text{k}\Omega; I_O = 2.9\text{mA})^{2}$	1.0	1.6	_	V <sub>p-p</sub>
<sup>t</sup> SET	Modulus Setup Time MC to Out <sup>3</sup>	_	6	9	ns
V <sub>in</sub>	Input Voltage Sensitivity 100–250MHz 250–1100MHz	400 100	_ _	1000 1000	mVpp

- 1. Divide Ratio of ÷8/9 at 1.1GHz,  $C_L = 8pF$ 2. Divide Ratio of ÷16/17 at 1.1GHz,  $C_L = 8pF$ 3. Assuming  $R_L = 560\Omega$  at 1.1GHz

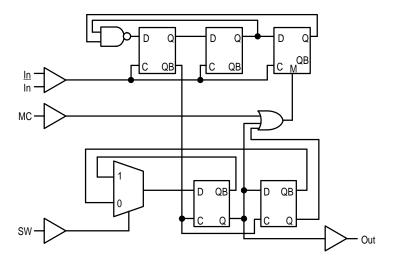
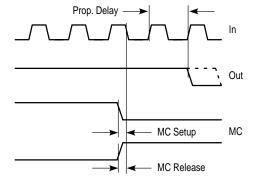


Figure 1. Logic Diagram (MC12026A)



Modulus setup time MC to out is the MC setup or MC release plus the prop delay.

Figure 2. Modulus Setup Time

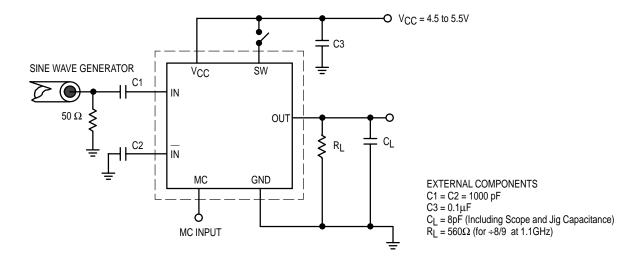


Figure 3. AC Test Circuit

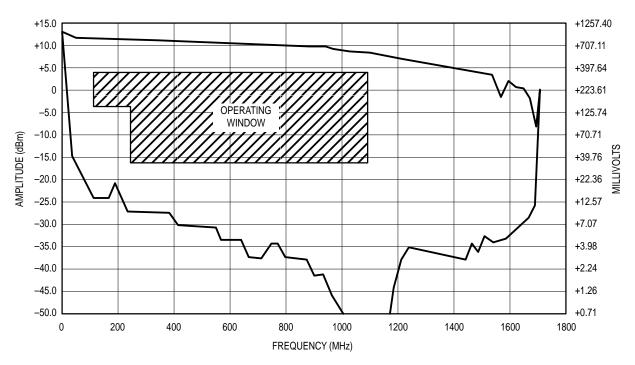


Figure 4. Input Signal Amplitude versus Input Frequency Divide Ratio = 8;  $V_{CC}$  = 5.0V;  $T_A$  = 25°C

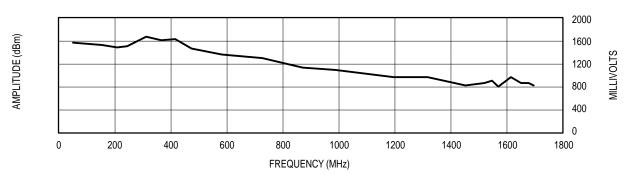
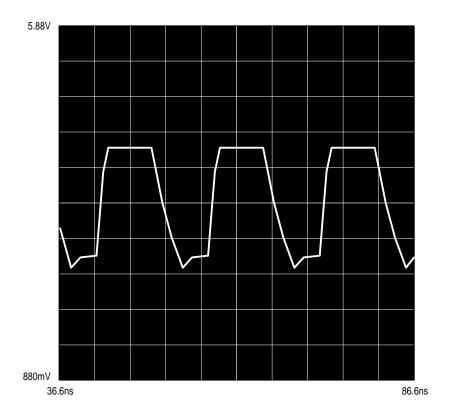


Figure 5. Output Amplitude versus Input Frequency



 $\label{eq:Figure 6. Typical Output Waveform} \ensuremath{(\div 8, 1.1 GHz \ Input \ Frequency, \ V_{CC} = 5.0, \ T_{A} = 25^{\circ}C, \ Output \ Loaded \ With \ 8pF)}$ 

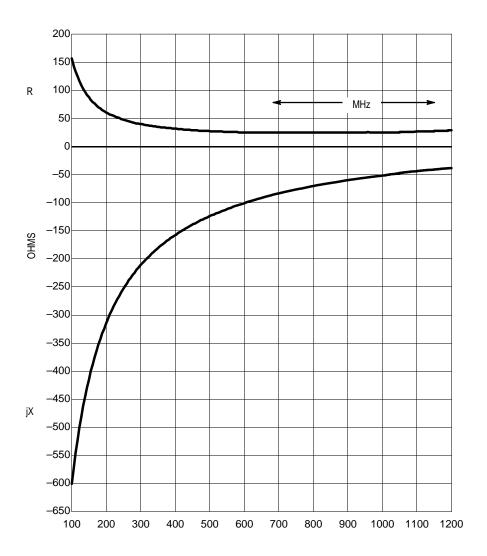
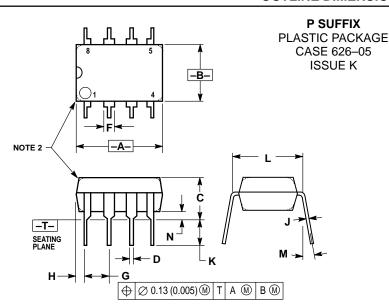


Figure 7. Typical Input Impedance versus Input Frequency

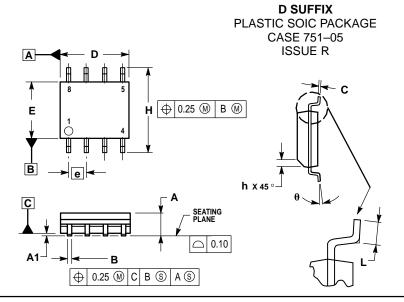
# **OUTLINE DIMENSIONS**



#### NOTES:

- DIMENSION L TO CENTER OF LEAD WHEN
  FORMED PARALLEL.
- PACKAGE CONTOUR OPTIONAL (ROUND OR SQUARE CORNERS).
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	9.40	10.16	0.370	0.400
В	6.10	6.60	0.240	0.260
C	3.94	4.45	0.155	0.175
D	0.38	0.51	0.015	0.020
F	1.02	1.78	0.040	0.070
G	2.54 BSC		0.100 BSC	
Н	0.76	1.27	0.030	0.050
7	0.20	0.30	0.008	0.012
K	2.92	3.43	0.115	0.135
L	7.62 BSC		0.300 BSC	
М		10°		10°
N	0.76	1.01	0.030	0.040



#### NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DIMENSION D AND E DO NOT INCLUDE MOLD
- PROTRUSION.
  4. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
- 5. DIMENSION B DOES NOT INCLUDE MOLD PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 TOTAL IN EXCESS OF THE B DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIMETERS		
DIM	MIN	MAX	
Α	1.35	1.75	
A1	0.10	0.25	
В	0.35	0.49	
С	0.18	0.25	
D	4.80	5.00	
E	3.80	4.00	
е	1.27 BSC		
Н	5.80	6.20	
h	0.25	0.50	
L	0.40	1.25	
θ	0 °	7°	

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#### How to reach us:

**USA/EUROPE/Locations Not Listed**: Motorola Literature Distribution; P.O. Box 5405; Denver, Colorado 80217. 303–675–2140 or 1–800–441–2447

Mfax™: RMFAX0@email.sps.mot.com – TOUCHTONE 602–244–6609 INTERNET: http://Design–NET.com

**JAPAN**: Nippon Motorola Ltd.; Tatsumi–SPD–JLDC, 6F Seibu–Butsuryu–Center, 3–14–2 Tatsumi Koto–Ku, Tokyo 135, Japan. 81–3–3521–8315

ASIA/PACIFIC: Motorola Semiconductors H.K. Ltd.; 8B Tai Ping Industrial Park, 51 Ting Kok Road, Tai Po, N.T., Hong Kong. 852–26629298



MC12026A/D